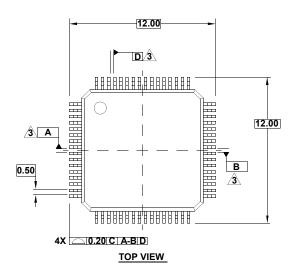
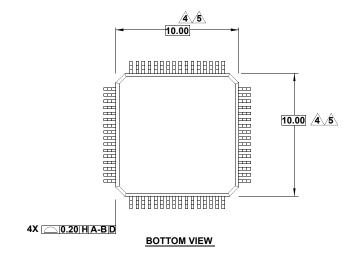
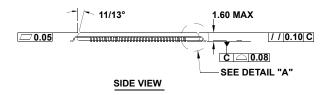
Package Outline Drawing

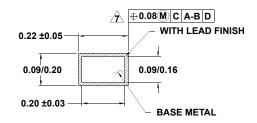
Q64.10x10A

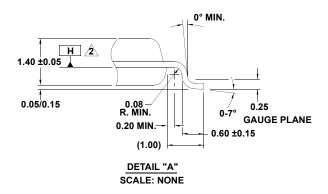
64 LEAD LOW PLASTIC QUAD FLATPACK PACKAGE (LQFP)
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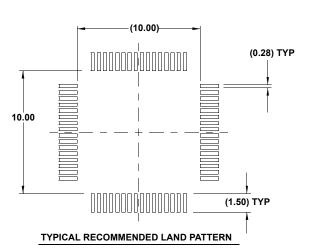












NOTES:

- 1. All dimensioning and tolerancing conform to ANSI Y14.5-1982.
- Datum plane located at mold parting line and coincident with lead, where lead exits plastic body at bottom of parting line.
- 3. Datums A-B and D to be determined at centerline between leads where leads exit plastic body at datum plane H.
- 4. Dimensions do not include mold protrusion. Allowable mold protrusion is 0.254mm.
- 5. These dimensions to be determined at datum plane H.
- 6. Package top dimensions are smaller than bottom dimensions and top of package will not overhang bottom of package.
- /i> Dimension does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm total at maximum material condition. Dambar cannot be located on the lower radius or the foot.
- 8. Controlling dimension: millimeter.
- 9. This outline conforms to JEDEC publication 95 registration MS-026, variation ACD.
- 10. Dimensions in () are for reference only.

